

High Reliability Chip - COG 16Vdc to 10kVdc

A range of MLC chip capacitors in Ultra stable EIA Class I COG, or NPO, dielectric with special testing for long term reliability. They are designed for optimum reliability; burned in at elevated voltage and temperature, and 100% physically and electrically inspected to ascertain conformance to strict performance criteria. Units may be tested in accordance with MIL-PRF-55681, MIL-PRF-123, MIL-PRF-49467, or customer SCD.

Designed for surface mount application with nickel barrier terminations making them suitable for solder wave and reflow solder board attachment as well as vapor phase attachment for part sizes 2225 or smaller. Silver-palladium terminations are also available for hybrid use with conductive epoxy.

COG chips are used in precision circuitry requiring Class I stability and exhibit linear temperature coefficient, low loss and stable electrical properties with time, voltage & frequency.

They find application for High Reliability use such as medical implanted devices, aerospace, airborne and military use as well as consumer uses requiring safety margins not attainable with commercial products.

Standard EIA case sizes and available C/V values are listed below - special sizes, thicknesses and other voltage ratings are available; please contact the sales office for information.

Capacitance and voltage selection for popular chip sizes

•															
Size	0402	0504	0603	0805	1206	1206	1210	1515	18	08	18	12	18	25	
Min cap.	OR3	OR5	OR3	OR5	OR5	3R0	5R0	3R0	5R0	5R0	100	100	150	150	
Tmax inches:	0.024 0.61	0.044 1.12	0.035 0.89	0.054 1.37	0.054 1.37	0.064 1.63	0.065 1.63	0.130 3.02	0.065 1.63	0.080* 2.03	0.065 1.63	0.100* 2.54	0.080 2.03	0.140* 3.56	
16V	81	152	102	392	562	103	223	393	223	273	473	473	104	104	
25V	181	152	102	392	562	123	223	393	223	273	473	473	104	104	
50V	181	152	102	392	562	123	223	333	183	223	393	393	104	104	
100V	101	821	561	222	332	682	123	273	123	183	273	273	683	823	
200V	101	561	331	152	222	392	822	223	822	103	153	273	473	683	
250V	390	391	271	102	152	272	562	183	562	682	123	183	273	473	
300V				681	681	182	392	123	392	472	822	123	223	273	
400V	•	•	•	681	561	152	392	822	392	472	822	103	183	183	
500V				681	561	152	392	682	392	392	822	103	183	183	
600V	•	•	•	•	•	122	392	682	392	392	822	103	183	183	
800V [†]						102	222	472	222	222	472	682	123	153	
1kV [†]	•	•	•	•	•	681	152	392	152	152	332	562	822	123	
1.5kV [†]						271	681	222	681	102	152	222	392	682	
2kV [†]	•	•	•	•	•	151	391	122	391	391	821	122	222	392	
3kV [†]								561	181	181	391	561	102	182	
4kV [†]	•	•	•	•	•	•	•	•	•	•	•	•	391	681	
5kV†													221	471	
6kV [†]	•	•	•	•	•	•	•	•	•	•	•	•	•	•	
7kV [†]															
8kV [†]	•	•	•	•	•	•	•	•	•	•	•	•	•	•	
9kV†															
10kV [†]	•	•	•	•	•	•	•	•	•	•	•	•	•	•	

[†] Units rated above 800V may require conformal coating to preclude arcing over chip surface Maximum voltage for MIL-PRF-123 tested parts is 1kV



High Reliability Chip - COG 16Vdc to 10kVdc







- For dielectric characteristics see page 4.
- For dimensions see page 12.
- For termination options see pages 3 & 15.
- For capacitance tolerances available see page 15.
- For ordering information see page 15.

Note: Maximum capacitance values are shown below as 3 digit code: 2 significant figures followed by the no. of zeros e.g. 183 = 18,000pF.

Capacitance and voltage selection for popular chip sizes

2020	2221	22	25	2520	3333	3530	4040	4540	5440	5550	6560	7565	Size
270	270	270	270	390	390	390	390	390	390	390	560	101	Min cap.
0.180 4.57	0.080 2.03	0.080 2.03	0.150* 3.81	0.180 4.57	0.250 6.35	0.250 6.35	0.300 7.62	0.300 7.62	0.300 7.62	0.300 7.62	0.300 7.62	0.300 7.62	:inches Tmax :mm
683	104	124	124	104	184	184	334	334	334	394	684	824	16V
683	104	124	124	104	184	184	334	334	334	394	684	824	25V
683	104	124	124	104	154	184	274	334	274	394	564	824	50V
563	683	823	104	823	124	154	224	274	224	274	474	564	100V
473	393	473	823	683	104	104	184	184	184	224	394	474	200V
393	223	273	563	563	823	104	154	184	184	224	394	474	250V
333	183	273	473	473	823	823	154	154	154	184	334	394	300V
223	183	273	273	333	563	563	124	124	124	154	274	334	400V
153	183	273	273	183	473	473	823	104	104	124	224	274	500V
153	183	273	273	183	393	393	683	823	823	124	184	274	600V
103	103	153	223	123	333	333	563	683	683	104	154	184	800V [†]
103	822	123	183	123	273	273	473	563	563	823	124	184	1kV [†]
682	392	562	103	822	183	183	333	393	393	563	823	124	1.5kV [†]
392	182	272	562	472	153	153	223	273	333	473	683	823	2kV [†]
182	821	122	272	222	682	682	153	183	183	273	393	473	3kV [†]
681	331	471	102	102	272	272	562	682	822	103	153	223	4kV [†]
391	221	331	681	561	182	182	392	472	472	682	103	123	5kV†
•	•	•	•	•	152	152	272	332	332	472	822	822	6kV⁺
						821	152	182	182	272	392	472	7kV†
•	•	•	•	•	•	•	102	122	122	182	272	392	8kV†
								821	102	122	222	272	9kV†
•	•	•	•	•	•	•	•	681	821	122	182	222	10kV⁺

^{*} Denotes non standard chip thickness. Order code needs to have an 'X' inserted together with the dimension in inches e.g. X080 where dimension is 0.080"











Chip Ordering Information





Prefix -	Case Size	Dielectric	Capacitance	Capacitance	lolerance	Voltage	-	lermination	:	Special Thickness		High Reliability	6	Packaging			Marking		High Reliability	Tect Criteria
(X	1206	N	472	J		101	1	V)	(050		Н		Т	•	- 1	M	Н	Н	В
	C		·																	
	Capacit	ance C	.oae			I					1,						<u> </u>			
	1st two digi		1R0 = 1.0pF		Sp	pecial Th	ickn	ess				Pack	agi	ng			rkin			
	significant, digit denote		120 = 12pF		No							None	Bulk			None	Unr	narke	b	
	number of :	zeros,	471 = 470pF			as per No catalog s						T	Тар	e & Re	el	М		rked arking r	not	
	R = decimal Examples:		102 = 1,000pF		Х	_	•		+			W	Waf	fle Pa	ck		avail	able or	1	
				-		thickness	s other	than									sizes	s <u><</u> 060	3	
		_	$273 = 0.027 \mu F$			standard inches if				Hial	n Do	liabi	lity			Hi-R	olio	hilit		
			474 = 0.47µF			(As show				_		IIabi	псу			Testi			•	
						,				ΙΔCΤ										
			105 = 1.0µF			= 0.050"				Test	_	dard pr	oduct				_			
			· · · · · · · · · · · · · · · · · · ·			,]	None	Stan	dard pro			۲	HB N	1IL-PR	F-5568	31 Gro	ou
Die	lectric Codes		· · · · · · · · · · · · · · · · · · ·			,				None H	Stand	Reliabil	ity Te	esting	{	HB N HV N	IIL-PR	F-5568 F-4940	81 Gro 67 Gro	ou
	lectric Codes		105 = 1.0μF			,				None	Stand		ity Te	esting	{	HB N HV N	IIL-PR	F-5568 F-4940	31 Gro	ou
N	COG/NP0	Ultra Sta	105 = 1.0μF able	e		,				None H	Stand High High	Reliabil	ity Te	esting	{	HB M	IIL-PR	F-5568 F-4940	81 Gro 67 Gro	ou
		Ultra Sta	105 = 1.0µF able able Magnetic Fre			,				None H	Stand High High	Reliabil	ity Te	esting	{	HB M	IIL-PR	F-5568 F-4940	81 Gro 67 Gro	ou
N M	COG/NPO	Ultra Sta Ultra Sta High Ter	105 = 1.0μF able)		= 0.050"	")			None H	Stand High High	Reliabil	ity Te	esting ning n Co	{	HB M	IIL-PR	F-5568 F-4940	81 Gro 67 Gro	ou
N M F	COG/NPO COG/NPO	Ultra Sta Ultra Sta High Ter	able mp. (up to 160°C mp. (up to 200°C)		= 0.050" Voltage	Cod	le		None H	Stand High High Ter P PR	Reliabil Temp S mina Pallac	ity Te	ning n Co Silver Silver*	{ ¦	HB MHV MHS M	IIL-PR	F-5568 F-4940	81 Gro 67 Gro	ou
N M F D	COG/NPO COG/NPO COG/NPO	Ultra Sta Ultra Sta High Ter	able able Magnetic Fremp. (up to 160°C mp. (up to 200°C able)		Voltage 1st two digit:	Codes are si	le gnifica	int,	None H	Stand High High Ter P PR K	Reliabil Temp S mina Pallac Pallac Solde	ity Te Screen Atio lium S lium S	ning n Co Silver Silver* Pallac	{ ¦	HB MHV MHS M	IIL-PR	F-5568 F-4940 F-123	81 Group	ou
N M F D	COG/NPO COG/NPO COG/NPO COG/NPO R3L R2D Y5V	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er	able able Magnetic Fremp. (up to 160°C mp. (up to 200°C able)		= 0.050" Voltage	Codes are signotes in	le gnifica numbe	int,	None H	Stand High High Ter P PR K N	Reliabil Temp S mina Pallac Pallac Solde Nicke	ity Te Screen Iium S Iium S Iium S rable	ning n Co Silver Silver* Pallac	{ ¦	HB MHV MHS M	IIL-PR	F-5568 F-4940 F-123	81 Group Group	ou p A
N M F D K R Y	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General General	able able Magnetic Fremp. (up to 160°C able to 200°C able ergy)		Voltage 1st two digit: third digit de	Codes are signotes in ample:	le gnifica numbe	int,	None H	Stand High High Ter P PR K N Y	Reliabil Temp S mina Pallac Pallac Solde Nicke	ity Te Screen Iium S Iium S rable I Barr I Barr	ning n Co Silver Silver* Pallactier*	odes	HB MHV MHS MHS	IIL-PR	F-5568 F-4940 F-123	81 Group	ou p A
N M F D K R Y Z	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General General Stable	able able Magnetic Fremp. (up to 160°C) mp. (up to 200°C) able ergy Purpose Purpose)		Voltage 1st two digit: third digit de zeros. For exit	Codes are signotes in ample:	le gnifica numbe	int,	None H	Stand High High Ter P PR K N Y	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke	atio lium S lium S lium S lium S rable I Barr I Barr I Barr	ning n Co Silver Silver* Pallac rier*	odes	HB MHV MHS	11L-PR 11L-PR 11L-PR 11L-PR 1100 904	F-5568 F-4946 F-123 D% tir % tin,	81 Group Group 1	ou p A
N M F D K R Y Z B C	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General General Stable Stable N	able able Magnetic Fremp. (up to 160°C) able mergy Purpose)		Voltage 1st two digit: third digit de zeros. For exa 160 = 16 N 101 = 100	Codes are signotes in ample:	le gnifica numbe	int,	None H	Stannon High High High PPR KN YNG C	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke FlexiC	ity Te tio tio stillium S rable I Barr I Barr I Barr I Barr	ning n Co Silver Silver* Pallac rier* rier rier Go	dium S	HB N HV N HS N Silver*	100 90°	F-5568 F-4940 F-123 D% tirn,	81 Group Group 1 10%	ou p #
N M F D K R Y Z B C X	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General General Stable Stable MIL	able able Magnetic Fremp. (up to 160°C able mp. (up to 200°C able mergy Purpose Purpose Magnetic Free)	-	Voltage 1st two digit: third digit de zeros. For exa 160 = 16 N 101 = 100	Codes are signature ample: Volts Volts Volts	le gnifica numbe	int,	None H	Stand High High Ter P PR K N Y NG C	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke Nicke FlexiC	ity Tee	esting ning n Co Silver Silver* Pallac rier* rier Go VNicke	dium S	HB N HV N HS N Silver*	100 90 90	F-5568 F-4944 F-123 97% tin, % tin,	31 Grcc Group 110%	ou p #
N M F D K R Y Z B C X S	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General Stable Stable N MIL High Tei	able able Magnetic Fremp. (up to 160°C able mergy Purpose Magnetic Free mp. (up to 150°C)	-	Voltage 1st two digit: third digit de zeros. For exi 160 = 16 \(\) 101 = 100 501 = 500 102 = 1,00	Cod s are si ample: 0 Volts 0 Volts 0 Volts 00 Volt	e gnifica	int,	None H	Stannon High High High PPR KN YNG C	mina Pallac Pallac Solde Nicke Nicke FlexiC Copp	ity Te correct ity Te correct	ning n Co Silver Pallac ier* rier Grier Go //Nicke	dium S	HB N HV N HS N Silver*	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 9% tirn, % tin, % tin, % tin,	31 Green	ou p A
N M F D K R Y Z B C X	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R Class II	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General General Stable N MIL High Tei	able able Magnetic Fremp. (up to 160°C able pergy Purpose Magnetic Free mp. (up to 150°C mp. (up to 150°C mp. (up to 200°C)		Voltage 1st two digit: third digit de zeros. For ex: 160 = 16 \cdot 101 = 100 501 = 500 102 = 1,00 502 = 5,00	Cod s are si sample: 0 Volts 0 Volts 00 Volt	gnifica gnifica tts	int,	None H	Stand High High Ter P PR K N Y NG C D B	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke Nicke FlexiC	ity Te correct Itio It	ning n Co Silver Pallac ier* rier Grier Go //Nicke	dium S	HB N HV N HS N Silver*	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 9% tirn, % tin, % tin, % tin,	31 Grcc Group 110%	ou p A
N F D K R Y Z B C X S E	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R	Ultra Sta Ultra Sta High Tei High Tei Ultra Sta Pulse Er General General Stable N MIL High Tei	able able Magnetic Fremp. (up to 160°C able mergy Purpose Magnetic Free mp. (up to 150°C)		Voltage 1st two digit: third digit de zeros. For exi 160 = 16 \(\) 101 = 100 501 = 500 102 = 1,00	Cod s are si sample: 0 Volts 0 Volts 00 Volt	gnifica gnifica tts	int,	None H	Stand High High Ter P PR K N Y NG C D B E S	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke FlexiC Copp Copp Silver	ity Te creer atio atio stillium S rable I Barr I Barr I Barr Eap ap ap ap ap ap ap ap ap ap	esting n Co n Co n Silver Pallac rier* rier Gc VNicke VNicke rrier*	Prodes	HB NV NHS	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 9% tirn, % tin, % tin, % tin,	31 Green	ou p A
N M F D K R Y Z B C X S E E G	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R Class II Class II	Ultra State Ultra State High Ter Ultra State Pulse Er General Stable Stable N MIL High Ter High Ter High Ter Stable	able able Magnetic Fremp. (up to 160°C mp. (up to 200°C able mergy Purpose Purpose Magnetic Free mp. (up to 150°C mp. (up to 200°C mp. (up to 160°C)		Voltage 1st two digit: third digit de zeros. For ex: 160 = 16 \cdot 101 = 100 501 = 500 102 = 1,00 502 = 5,00	Cod s are si sample: 0 Volts 0 Volts 00 Volt	gnifica gnifica tts	int,	None H	Stand High High Ter P PR K N Y NG C D B E S	mina Pallac Pallac Solde Nicke Nicke FlexiC Copp	ity Te creer atio atio stillium S rable I Barr I Barr I Barr Eap ap ap ap ap ap ap ap ap ap	esting n Co n Co n Silver Pallac rier* rier Gc VNicke VNicke rrier*	Prodes	HB NV NHS	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 9% tirn, % tin, % tin, % tin,	31 Green	ou p A
M F D K R Y Z B C X S E G W	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R Class II Class II X5R	Ultra State Ultra State High Ter Ultra State Pulse Er General Stable Stable N MIL High Ter High Ter High Ter Stable	able able Magnetic Fremp. (up to 160°C mp. (up to 200°C able mergy Purpose Purpose Magnetic Free mp. (up to 150°C mp. (up to 200°C mp. (up to 160°C)	-	Voltage 1st two digit: third digit de zeros. For exa 160 = 16 v 101 = 100 501 = 500 102 = 1,00 502 = 5,00 103 = 10,00	Codos s are si sample: Volts Volts Volts OVOID Volts OVOID VOID VOID	le gnifica numbe	ant, er of	None H H	Stand High High Ter P PR K N Y NG C D B E S * Indeed	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke FlexiC Copp Copp Silver	ity Te creer atio atio stillium S rable I Barr I Barr I Barr Eap ap ap ap ap ap ap ap ap ap	esting n Co n Co n Silver Pallac rier* rier Gc VNicke VNicke rrier*	Prodes	HB NV NHS	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 9% tirn, % tin, % tin, % tin,	31 Green	ou p /
N M F D K R R Y Z B C X S E G W W RN	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R Class II Class II X5R Lead free COG/NPO	Ultra State Ultra State High Tei High Tei Ultra State Pulse Er General General Stable Stable MIL High Tei High Tei High Tei Stable Ultra Stable Ultra Stable	able able Magnetic Fremp. (up to 160°C mp. (up to 200°C able mergy Purpose Purpose Magnetic Free mp. (up to 150°C mp. (up to 200°C mp. (up to 160°C)	-	Voltage 1st two digit: third digit de zeros. For ex: 160 = 16 \cdot 101 = 100 501 = 500 102 = 1,00 502 = 5,00	Codos s are si sample: Volts Volts Volts OVOID Volts OVOID VOID VOID	le gnifica numbe	ant, er of	None H H	Stand High High Ter P PR K N Y NG C D B E S	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke FlexiC Copp Copp Silver	ity Te creer atio atio stillium S rable I Barr I Barr I Barr Eap ap ap ap ap ap ap ap ap ap	esting n Co n Co n Silver Pallac rier* rier Gc VNicke VNicke rrier*	Prodes	HB NV NHS	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 9% tirn, % tin, % tin, % tin,	31 Green	ou p /
N M F D K R Y Z B C X S E G W RN RB	COG/NPO COG/NPO COG/NPO R3L R2D Y5V Z5U X7R X7R BX X8R Class II Class II X5R Lead free COG/NPO Lead free X7R	Ultra State Ultra State High Tei High Tei Ultra State Pulse Er General General Stable Stable MIL High Tei High Tei High Tei Stable Ultra Sta	able able Magnetic Fremp. (up to 160°C mp. (up to 200°C able mergy Purpose Purpose Magnetic Free mp. (up to 150°C mp. (up to 200°C mp. (up to 160°C)))))	Сар	Voltage 1st two digit: third digit de zeros. For exa 160 = 16 v 101 = 100 501 = 500 102 = 1,00 502 = 5,00 103 = 10,00	Codos s are si sample: Volts Volts Volts OVOID Volts OVOID VOID VOID	le gnifica numbe	ant, er of	H H	Stann High High Ter P PR K N Y NG C D B E S * Inc	Reliabil Temp S mina Pallac Pallac Solde Nicke Nicke FlexiC Copp Copp Silver dicates	ity Te creer atio atio stillium S rable I Barr I Barr I Barr Eap ap ap ap ap ap ap ap ap ap	esting n Co n Co n Silver Pallac rier* rier Gc VNicke VNicke rrier*	Prodes	HB MV MV MS NV MS	100 90° 100 100 100 100 100 100 100 100 100 1	F-5568 F-4944 F-123 70% tin, 70% tin, 70% tin, 70% tin,	81 Group 57 Group 1 10%	le le

Pref	Prefix Definitions								
None	Standard chip								
RF	Improved ESR Capacitor	p. 23							
LS	Y ³ Certified Safety Capacitor	p. 42 - 43							
ES	Y ² Certified Safety Capacitor	p. 42 - 43							
ST	Stacked Capacitor Assembly	p. 48 - 53							
SM	Stacked Hi-Rel Capacitor Assembly	p. 48 - 53							
CR	Cap-Rack Capacitor Array	p. 54							
RC	Bleed Resistor	p. 58 - 61							

Сар	acitance	101	ciai	100	cou	-3									
Code	Tolerance		COG/NPO		R3L	R2D	Y5V Z5U	X	7R	вх	X8R	Class II	X5R	Positive VTC	
	* Not RF series		N	M	F/D	K	R	Y/Z	В	C	Х	S	E/G	W	Р
В	±0.10pF	e	•	•											
С	±0.25pF	Cap. Value < 10pF	•	•		•									
D	±0.50pF	ů,	•	•		•									
F	±1%		•	•	•										
G	±2%		•	•	•	•									
J	±5%		•	•	•	•	•		•*	•	•*	•	•		
K	±10%		•	•	•	•	•		•	•	•	•	•	•	•
М	±20%		•		•	•	•	•	•	•	•	•	•	•	•
Z	+80% -20%		•				•	•	•*						•
Р	+100% -0%		•				•	•	•*						•

Technical Summary



Novacap provides application notes throughout this catalog as a guide to chip selection and attachment methods. Refer to the Novacap Technical Brochure found at www.novacap. com for more details. This technical information includes the nature of capacitance, dielectric properties, electrical properties, classes of dielectrics, ferroelectric behavior, test standards, and high reliability test plans. Please do not hesitate to contact the sales office for any product or technical assistance.

Capacitor Size

Size availability is based primarily on capacitance values and voltage rating. Smaller units are generally less expensive. Because mass affects the thermal shock susceptibility of chip capacitors, size selection should consider the soldering method used to attach the chip to the board. Sizes 1812 and smaller can be wave, vapor phase, or reflow soldered. Larger units require reflow soldering.

Chip Selection

Multilayer capacitors (MLC) are categorized by dielectric performance with temperature. The Temperature Coefficient of Capacitance describes the variance of capacitance value with temperature. The choice of components is therefore largely determined by the temperature stability required of the device and the size necessary for the desired capacitance value and voltage rating.

Packaging

Units are available reeled, in waffle pack, or bulk packaged. Bar coded labels are standard for reeled and bulk packaging.

Primary Dielectric Types

COG/NPO:

Ultra stable Class I dielectric, with negligible dependence of capacitance on temperature, voltage, frequency, and time. Used in circuitry requiring very stable performance.

X7R:

Stable Class II dielectric, with predictable change in properties across a temperature range of -55°C to +125°C. Used as blocking, decoupling, bypassing, and frequency discriminating elements. This dielectric is ferroelectric and provides higher capacitance than Class I materials.

BX:

The military specification for ceramic chip capacitors (MIL-PRF-55681) defines a mid-K stable dielectric designated as BX. The BX specification has voltage temperature limits in addition to temperature limits of capacitance. The BX dielectric is limited to ±15% maximum change in capacitance between 25°C and -55°C or +125°C and also has a voltage restriction of +15% / -25% maximum change in capacitance between 25°C and -55°C or +125°C at rated voltage.

Z5U/Y5V:

General purpose Class III dielectrics with higher dielectric constant and greater variation of properties over temperature and voltage. Very high capacitance per volume is attainable for general purpose applications where stability over a wide temperature range is not critical.

Dielectric Termination Combinations		Palladium Silver	SHO Palladium Silver	Solderable Palladium Silver	Nickel Barrier 100% tin	Nickel Barrier 90/10% tin/lead	Nickel Barrier Gold flash	FlexiCap TM /Nickel Barrier 100% tin	FlexiCap TM /Nickel Barrier 90/10% tin/lead	Copper Barrier	Copper Barrier 90/10% tin/lead	Solderable Silver
Dielectric	Code	P	PR	K	N	Υ	NG	С	D	В	E	S
COG/NP0	N/RN			•	•			•				•
R3L	K	•	•	•	•	•	•	•	•			
X7R	B/RB	•	•	•	•	•	•	•	•			•
X7R BME	ВВ				•	•	•					
X5R BME	BW				•	•	•					
BX	Х	•	•	•	•	•	•	•	•			•
Y5V	Y							•	•			
Z5U	Z							•	•			
COG/NPO (Mag free)	M											
X7R (Mag free)	С	•	•	•						•	•	
X8R	S		•	•	•	•		•	•			•
C0G/NP0 (160°C)	F	•	•	•	•	•		•	•			•
C0G/NP0 (200°C)	D			•								•
Class II (160°C)	G	•	•	•	•	•		•	•			•
Class II (200°C)	E			•								•
Pulse Power	P	•	•	•								
R2D	R											

Termination Material

We recommend the following termination types:

Solder Attachment:

- N Nickel Barrier, 100% matte tin plated - RoHS
- **C** FlexiCap™ with Nickel Barrier, 100% tin plated - RoHS
- Y Nickel Barrier, tin-lead plated
- **D** FlexiCap™ Nickel Barrier, tin-lead plated
- **B** Copper Barrier 100% matte tin plated - RoHS
- **E** Copper Barrier, tin-lead
- K Solderable Palladium Silver -RoHS (suitable for conductive epoxy attach)
- **S** Solderable Silver RoHS

Conductive Epoxy attachment:

- P Palladium Silver
- PR Palladium Silver RoHS
- NG Nickel Barrier Gold Flash -RoHS (suitable for soldering attach)



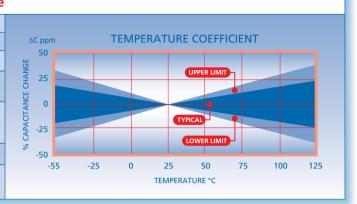


Dielectric Characteristics

COG/NPO (N) Ultra Stable and RoHS 2013 (RN) type Operating temperature range: -55°C to 125°C Temperature coefficient: 0 ±30 ppm/°C

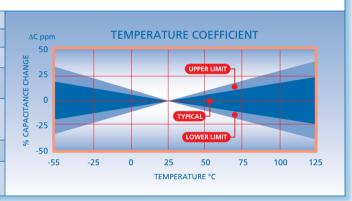
withstanding 201-500V: 150% or 500V whichever is greater voltage >500V: 120% or 750V whichever is greater Ageing rate: 0% per decade

Test parameters: 1KHz, 1.0 ±0.2 VRMS, 25°C 1MHz for Capacitance ≤100pF



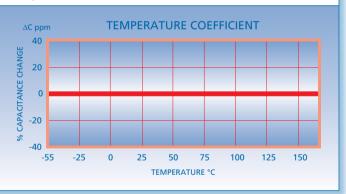
COG/NPO (M) Ultra Stable Non Magnetic

` '	-
Operating temperature range:	-55°C to 125°C
Temperature coefficient:	0 ±30 ppm/°C
Dissipation factor:	0.1% max @ 25°C
Insulation resistance @25°C: @125°C:	>1000 Ω F or >10000 Ω F whichever is less >100 Ω F or >1000 Ω F whichever is less
Dielectric ≤200V: withstanding 201-500V: voltage >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:	0% per decade
Test parameters:	1KHz, 1.0 ±0.2 VRMS, 25°C 1MHz for Capacitance ≤100pF



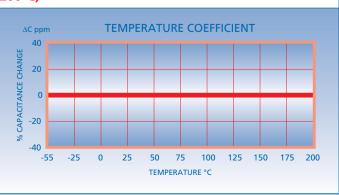
COG/NPO (F) Ultra Stable High Temperature (up to 160°C)

Operating temperature range:	-55°C to 160°C
Temperature coefficient:	0 ±30 ppm/°C
Dissipation factor:	0.1% max @ 25℃
Insulation resistance @25°C: @160°C:	>100G Ω or >1000 Ω F whichever is less >1G Ω or >10 Ω F whichever is less
Dielectric <200V: withstanding 201-500V: voltage >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:	0% per decade
Test parameters:	1KHz, 1.0 ±0.2 VRMS, 25°C 1MHz for Capacitance ≤100pF



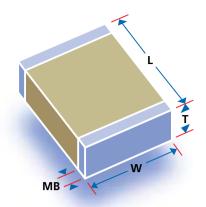
COG/NPO (D) Ultra Stable High Temperature (up to 200°C)

000,1110(2)0		o mgm remperature (up to
Operating temperature	range:	-55°C to 200°C
Temp. coefficient ≤200	O°C:	0 ±30 ppm/°C
Dissipation factor @ 25	5°C:	0.1% Max.
Insulation resistance	@25°C: @200°C:	>100G Ω or >1000 Ω F whichever is less >1G Ω or >10 Ω F whichever is less
Dielectric withstanding voltage	≤200V: 201-500V: >500V:	250% 150% or 500V whichever is greater 120% or 750V whichever is greater
Ageing rate:		0% per decade
Test parameters:		1KHz, 1.0 ±0.2 VRMS, 25°C 1MHz for capacitance ≤100pF





Chip Dimensions



Dimensi	ions - inches (mm)			
Size	Length (L)	Width (W)	Max. Thickness (T)*	Termination Band (MB)
0402	0.040 ± 0.004 (1.02 ± 0.102)	0.020 ± 0.004 (0.508 ± 0.102)	0.024 (0.610)	0.010 ± 0.006 (0.254 ± 0.152)
0504	0.050 ± 0.006 (1.27 ± 0.152)	0.040 ± 0.006 (1.02 ± 0.152)	0.044 (1.12)	0.014 ± 0.006 (0.356 ± 0.152)
RF0505	0.055 +0.015 -0.010 (1.4 +0.38 -0.25)	0.055 ± 0.015 (1.40 ± 0.381)	0.057 (1.45)	0.014 ± 0.006 (0.356 ± 0.152)
0603	0.060 ± 0.006 (1.52 ± 0.152)	0.030 ± 0.006 (0.762 ± 0.152)	0.035 (0.889)	0.014 ± 0.006 (0.356 ± 0.152)
0805	0.080 ± 0.008 (2.03 ± 0.203)	0.050 ± 0.008 (1.27 ± 0.203)	0.054 (1.37)	0.020 ± 0.010 (0.508 ± 0.254)
0907	0.090 ± 0.008 (2.29 ± 0.203)	0.070 ± 0.008 (1.78 ± 0.203)	0.060 (1.52)	0.020 ± 0.010 (0.508 ± 0.254)
1005	0.100 ± 0.008 (2.54 ± 0.203)	0.050 ± 0.008 (1.27 ± 0.203)	0.054 (1.37)	0.020 ± 0.010 (0.508 ± 0.254)
RF1111	0.110+0.025 -0.010 (2.79 +0.64 -0.25)	0.110 ± 0.015 (2.79 ± 0.381)	0.102 (2.59)	0.020 ± 0.010 (0.508 ± 0.254)
1206	0.125 ± 0.008 (3.18 ± 0.203)	0.060 ± 0.008 (1.52 ± 0.203)	0.064 (1.63)	0.020 ± 0.010 (0.508 ± 0.254)
1210	0.125 ± 0.008 (3.18 ± 0.203)	0.100 ± 0.008 (2.54 ± 0.203)	0.065 (1.65)	0.020 ± 0.010 (0.508 ± 0.254)
1515	0.150 ± 0.015 (3.81 ± 0.381)	0.150 ± 0.015 (3.81 ± 0.381)	0.130 (3.30)	0.030 ± 0.015 (0.762 ± 0.381)
1808	0.180 ± 0.012 (4.57 ± 0.305)	0.080 ± 0.008 (2.03 ± 0.203)	0.065 (1.65)	0.024 ± 0.014 (0.610 ± 0.356)
1812	0.180 ± 0.012 (4.57 ± 0.305)	0.125 ± 0.008 (3.18 ± 0.203)	0.065 (1.65)	0.024 ± 0.014 (0.610 ± 0.356)
1825	0.180 ± 0.012 (4.57 ± 0.305)	0.250 ± 0.015 (6.35 ± 0.381)	0.080 (2.03)	0.024 ± 0.014 (0.610 ± 0.356)
2020	0.200 ± 0.015 (5.08 ± 0.381)	0.200 ± 0.015 (5.08 ± 0.381)	0.180 (4.57)	0.024 ± 0.014 (0.610 ± 0.356)
2221	0.220 ± 0.015 (5.59 ± 0.381)	0.210 ± 0.015 (5.33 ± 0.381)	0.080 (2.03)	0.030 ± 0.015 (0.762 ± 0.381)
2225	0.220 ± 0.015 (5.59 ± 0.381)	0.250 ± 0.015 (6.35 ± 0.381)	0.080 (2.03)	0.030 ± 0.015 (0.762 ± 0.381)
2520	0.250 ± 0.015 (6.35 ± 0.381)	0.200 ± 0.015 (5.08 ± 0.381)	0.180 (4.57)	0.030 ± 0.015 (0.762 ± 0.381)
RF2525	0.230 +0.020 -0.012 (5.84 +0.51 -0.30)	0.250 ± 0.015 (6.35 ± 0.381)	0.165 (4.19)	0.030 ± 0.015 (0.762 ± 0.381)
3333	0.330 ± 0.017 (8.38 ± 0.432)	0.330 ± 0.017 (8.38 ± 0.432)	0.250 (6.35)	0.030 ± 0.015 (0.762 ± 0.381)
3530	0.350 ± 0.018 (8.89 ± 0.457)	0.300 ± 0.015 (7.62 ± 0.381)	0.250 (6.35)	0.030 ± 0.015 (0.762 ± 0.381)
4040	0.400 ± 0.020 (10.2 ± 0.508)	0.400 ± 0.020 (10.2 ± 0.508)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
4540	0.450 ± 0.023 (11.4 ± 0.584)	0.400 ± 0.020 (10.2 ± 0.508)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
5440	0.540 ± 0.027 (13.7 ± 0.686)	0.400 ± 0.020 (10.2 ± 0.508)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
5550	0.550 ± 0.028 (14.0 ± 0.711)	0.500 ± 0.025 (12.7 ± 0.635)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
6560	0.650 ± 0.033 (16.5 ± 0.838)	0.600 ± 0.030 (15.2 ± 0.762)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)
7565	0.750 ± 0.038 (19.1 ± 0.965)	0.650 ± 0.033 (16.5 ± 0.838)	0.300 (7.62)	0.040 ± 0.020 (1.02 ± 0.508)

^{*} Non standard thicknesses are available - consult the sales office for details.



High Reliability Testing





Our High Rel products are designed for optimum reliability and are burned in at elevated voltage and temperature levels. They are 100% electrically inspected to ascertain conformance to a strict performance criteria.

Applications for High Reliability products include medical implanted devices, aerospace, airborne, various military applications, and consumer uses requiring safety margins not attainable with conventional product.

We have the ability to test surface mount and leaded capacitors to High Reliability standards as detailed below, or to customer SCD.

Military performance specifications are designed and written for the voltage/ capacitance ratings of the individual product slash numbers associated with the specification.

Some of the requirements of the military document may not apply to the NOVACAP High Reliability product. The following details the intent of the individual military specifications available for test and the deviations that may apply.

Product voltage ratings outside of the intended military specification will follow the NOVACAP voltage test potential outlined.

Contact the sales office with any requirements or deviations that are not covered here.

Environmental Testing

We also have the capability to perform all the Environmental Group B, Group C, and Qualification testing to the referenced military specifications.

Testing abilities include the following:

- Nondestructive internal examination
- · Destructive physical analysis
- Radiographic inspection
- Terminal strength
- Resistance to soldering heat
- Voltage-temperature limits
- Temperature coefficient
- Moisture resistance
- Humidity, steady state, low voltage
- Vibration
- Resistance to solvents
- Life
- Thermal shock and immersion
- Low temperature storage
- Barometric pressure
- Shock, specified pulse
- Mechanical shock
- Constant acceleration
- Wire bond evaluation
- Partial discharge (corona)
- 200°C Voltage Conditioning

Military Performance Specifications

MIL-PRF-55681 (GROUP A)

General purpose military high reliability specification for surface mount sizes 0805 through 2225 in 50V and 100V.

- VOLTAGE CONDITIONING
- 100 HRS, 2X VDCW, 125°C
- DWV, IR, 125°C IR, CAP, DF TEST
- VISUAL & MECH. INSPECTION (AOL SAMPLE PLAN)
- SOLDERABILITY, SAMPLE 13(0)
- 8% PDA MAXIMUM

MIL-PRF-123 (GROUP A)

The specification affords an increased reliability level over MIL-PRF-55681 for space, missile and other high reliability applications such as medical implantable or life support equipment. The specification covers surface mount sizes 0805 through 2225 in 50V rating and various radial / axial leaded products in 50V, 100V, and 200V ratings.

- THERMAL SHOCK, 20 CYCLES
- VOLTAGE CONDITIONING 168/264 HRS, 2X VDCW, 125°C
- DWV, IR, 125°C IR, CAP, DF TEST
- VISUAL & MECH. INSPECTION SAMPLE 20(0)
- PDA, 3% (0.1%), 5% (0.2%) MAX⁽²⁾

MIL-PRF-39014 (GROUP A)

The specification covers general military purpose radial / axial leaded and encapsulated product in 50V, 100V, and 200V ratings.

- THERMAL SHOCK, 5 CYCLES
- VOLTAGE CONDITIONING 96 HRS, 2X VDCW, 125°C
- DWV, IR, 125°C IR, CAP, DF TEST
- VISUAL & MECH. INSPECTION (AQL SAMPLE PLAN)
- SOLDERABILITY, SAMPLE 13(0)
- 8% PDA MAXIMUM

MIL-PRF-49467 (GROUP A)

General purpose military high reliability specification for radial leaded epoxy coated. The specification covers sizes 1515 through 13060 with 600V, 1000V, 2000V, 3000V, 4000V, and 5000V ratings.

- THERMAL SHOCK, 5 CYCLES
- VOLTAGE CONDITIONING 96 HRS. RATED VDCW, 125°C
- PARTIAL DISCHARGE (OPTION) (3)
- DWV, IR, 125°C IR, CAP, DF TEST
- VISUAL & MECH. INSPECTION SAMPLE 13(0)
- SOLDERABILITY, SAMPLE 5(0)
- 10% PDA MAXIMUM

MIL-PRF-49470 (DSCC 87106) (GROUP A)

General purpose military high reliability specification for stacked and leaded capacitors for switch mode power supplies. The specification covers sizes 2225 through 120200 in 50V, 100V, 200V and 500V ratings.

- THERMAL SHOCK, 5 CYCLES
- VOLTAGE CONDITIONING 96 HRS, 2X VDCW(4), 125°C
- DWV, IR, 125°C IR, CAP, DF TEST
- VISUAL & MECH. INSPECTION SAMPLE 13(0)
- SOLDERABILITY, SAMPLE 5(0)
- 10% PDA MAXIMUM

MIL-PRF-38534

Specification for Hybrid Microcircuits with a section for Element Evaluation on passive components

There are two classification levels of reliability. Class H is for a standard military quality level. Class K is for the highest reliability level intended for space application.

Novacap will perform a 100-hour burn-in on all Class K products. Novacap assumes Class K Subgroup 3 samples will be unmounted and Subgroup 4 (wirebond) shall not apply unless otherwise stated

NOVACAP TEST VOLTAGE (VDC)

This test potential shall be used on all High Reliability Testing unless otherwise specified.

WVDC	DWV	V/C*
<200	2.5X Rated	2.0X Rated
250	500V	400V
300	500V	400V
400	600V	500V
500	750V	600V
600	750V	600V
>700	1 2X Rated	1 0X Rated

*V/C Is Voltage Conditioning.

(1) MIL-PRF-123 DPA shall be per TABLE XIV AQL requirements unless otherwise specified.

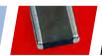
(2) MIL-PRF-123 allowable PDA shall be 3% overall and 0.1% in the last 48 hours for capacitance/ voltage values listed in MIL-PRF-123, and be 5% overall and 0.2% in the last 48 hours for capacitance/voltage values beyond MIL-PRF-123.

(3) MIL-PRF-49467 standard Group A is without Partial Discharge. Partial Discharge test is optional and must be specified.

(4) MIL-PRF-49470 (DSCC 87106) 500V rated product has Voltage Conditioning at 1.2X VDCW.



Product Reliability Groups





Novacap's management has defined and documented our Quality Policy.

Quality at Novacap is the enhancement of customer satisfaction by meeting our customer requirements in all our dealings with

Our Customers Our Vendors The Fnvironment

Our system for quality is to attain effective, continuous, measurable improvement through systematic prevention of defects and errors in all activities.

Quality and customer satisfaction are the responsibility of every Novacap employee.

Certifications and Approvals

Novacap is certified to ISO 9001:2008, Certificate #FM75371.

10 DSCC approvals for radial leaded high voltage capacitors rated 1KV through 10KV. (87043, 87046, 87040, 87047, 87114, 87076, 89044, 87070, 87077, and 87081) DSCC approval for 87106 stacked leaded switch mode power supply capacitors.

UL, TÜV and CSA approvals for Isolation Surge Protection Capacitors, Class Y² and Y³ in both COG and X7R dielectrics.



ISO 9001:2008 FM 75371





	Standard Commercial Capacitors	HH MIL-PRF-38534 Class H	HB MIL-PRF-55681	HK MIL-PRF-38534 Class K	HS MIL-PRF-123
Standard		•			
High Reliability			•	•	
Typical Termination Options					
P: Silver Palladium		•	•	•	
N: Silver base with Nickel Barrier (100% Matte Tin Plating)	•	•	•	0	٠
Y: Silver base with Nickel Barrier (Tin/Lead Plating with min 10% Lead)	•	•	•	•	
C: FlexiCap™ with Nickel Barrier (100% Matte Tin Plating)	•	•	•	•	•
D: FlexiCap™ with Nickel Barrier (Tin/Lead Plating with min 10% Lead)		•	•	•	
■ Termination available. □ Termination Novacap Sales.	available but genera	illy not requested for	Military/Space Grade	components. Please c	liscuss with
Documentation					
Certificate of Conformance	S	S	S	S	S
Electrical Test Report (10 piece read and record report)	0	S	0	S	0
Full Data Package	0	0	S	S	S





	Standard Commercial Capacitors	HH MIL-PRF-38534 Class H	HB MIL-PRF-55681	HK MIL-PRF-38534 Class K	HS MIL-PRF-123
Destructive Physical Analysis (DPA)	S	S	S	S	S
CSAM (C-Mode Scanning Acoustic Microscopy)	0	0	0	0	0
Plating Thickness Verification	S	S	S	S	S
Solderability*	S	S	S	S	S
Electrical Characteristics (DWV, IR, Cap, DF)	S	S	S	S	S
Sample Visual Inspection	S	S	S	S	S
100% Visual Inspection	0	0	0	S	S
Thermal Shock -55°C to +125°C	0	0	0	0	S
100% Burn-In**	0	0	S	S	S
100% Hot IR	0	0	0	0	S
Hot IR sample test (at rated voltage)	0	0	S	S	S
10 Piece Sample Temp Cycling, Constant Acceleration, Burn-In	0	0	0	S	0
Life Sample Test	0	0	0	0	0
Humidity Sample Test	0	0	0	0	0
Resistance to Soldering Heat Sample Test	0	0	0	0	0
Terminal Strength Sample Test	0	0	0	0	0
Group B Testing	N/A	N/A	N/A	N/A	0
Group C Testing	N/A	N/A	0	0	0

S = Test conducted as standard.



O = Optional test. Please discuss with Novacap Sales.

 $^{^{\}star}$ Solderability and plating thickness verification does not apply to palladium/silver terminations.

^{**} Burn-In for MIL-PRF-55681 and MIL-PRF-38534 Class K is 100 hours. Burn-In for MIL-PRF-123 is 168 to 264 hours.

Lot Test Details





DPA	Destructive Physical Analysis, Device is mounted in an epoxy plug and cross sectioned, with a fine grit sand paper while examining the internal construction of the device per relevant sections of EIA 469 and NOVACAP's internal design criteria.		
CSAM	C-Mode Scanning Acoustic Microscopy; A method of non-destructive analysis is of the internal construction of a device per MIL-PRF-123. The optional test is to assure the highest quality of internal microstructure.		
Plating Thickness Verification	X-Ray fluorescent [XRF) equipment/instrument is utilized to verily the plating thickness of a device according to NOVACAP's criteria.		
Solderability	Determines the ability for solder to wet/adhere to the termination by dipping the component into molten solder according to MIL-STD-202 Method 208.		
Electrical Characteristics (DWV, IR, Cap, DF)	DWV: Dielectric Withstanding Voltage, Determines the ability of the dielectric to withstand accelerated voltage without breaking down. IR: Insulation Resistance; The insulation resistance is a measure of the capability of a material To withstand leakage of current under a VDC potential gradient.		
Sample Visual Inspection	Is an AQL level inspection, which is based on lot size and consists of a bulk scan under microscope between 7-10X magnification.		
100% Visual Inspection	Each side of every part in a lot is subjected to inspection under microscope between 7-10X magnification in accordance with MIL-PRF-123 Appendix B.		
Thermal Shock -55°C to +125°C	Devices are subjected to sudden temperature extremes (hot and cold) to determine the physical integrity of the components. All parts receive 20 cycles in accordance with MIL-PRF-123.		
100% Burn-In	A method of screening infantile failures by testing at accelerated conditions. Product groups HB and HK follow the guidelines of MIL-PRF-55681. The parts receive a 100% Burn-in at 125°C and a voltage specified in page 27 for 100 hours. Product group HS follows the guidelines of MIL-PRF-123. The parts receive a 100% Burn-in at 125°C and a voltage specified in page 27 for a minimum of 168 and a maximum of 264 hours. The Burn-In may be terminated at any time between the hours of 168 and 264 when failures are less than 0.1% or 1 pieces during the last 48 hours of the test.		
100% Hot IR	Tested for IR at rated voltage and elevated temperatures.		
Hot IR sample test	A sample that is tested for IR at rated voltage and elevated temperatures.		
10 Piece Sample Temp Cycling, Constant Acceleration, Burn-In	The 10 piece sample is tested in accordance with MIL-PRF-38534 TABLE C-III Subgroup 3. The tests include Temperature Cycling per MIL-STD-883 Method 1010 Condition C, Constant Acceleration per MIL-STD-883 Method 2001 with 3,000g's in Y1 direction, Burn-in according to MIL-PRF-55681, and Visual inspection.		
Life Sample Test	A test that determines the long-term reliability of a device that is performed at accelerated electrical and environ mental conditions. Life test for product groups HH,HB, and HK shall be in accordance with MIL PRF-55681. Life test for product group HS shall be in accordance with MIL-PRF-123.		
Humidity Sample Test	Humidity, steady state, low voltage test in accordance with MIL-PRF-202 method 103 condition A with the capacitor requirements of MIL-PRF-55681/MIL-PRF-123. A twelve piece sample is tested with accept on zero failures.		
Resistance to Soldering Heat Sample Test	The ability of a device to withstand soldering temperatures. Capacitors shall be tested in accordance with MIL-STD-202 Method 210 with applicable detail of MIL-PRF-55681/MIL-PRF-123.		
Terminal Strength Sample Test	It is the strength of the adhesion of the termination to the ceramic body. Capacitors shall be tested in accordance with MIL-STD-202 Method 211 Test Condition A with applicable details of MIL-PRF-123. A six piece sample is tested with accept on zer failures.		
Group B Testing	Group B environmental testing for product group HS shall consist of the tests specified in table XII of MIL-PRF-123 and shall be performed on sample units from lots that have been subjected to and have passed group A inspection. Copies of Group B data shall be forwarded to purchaser with parts. Parts may not be shipped until the conclusion of life test.		
Group C Testing	Group C environmental testing shall consist of the tests specified in table XI of MIL-PRF-55681 for product groups HB and HK. Testing shall consist of the tests specified in table XIII of MIL-PRF-123 for product group HS. Tests shall be performed on sample units from lots that have been subjected to and have passed group A inspection. Copies of Group C data shall be forwarded to purchaser with parts. Parts may not be shipped until the conclusion of life test.		

